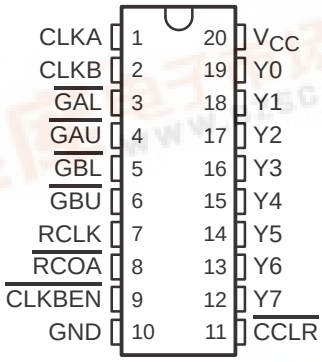
DUAL 16-BIT BINARY COUNTERS WITH 3-STATE OUTPUT REGISTERS

SCLS589 – AUGUST 2004

- Can Be Used as Two 16-Bit Counters or a Single 32-Bit Counter
- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 25 ns at 5 V (RCLK to Y)
- Typical V_{OLP} (Output Ground Bounce) <0.7 V at V_{CC} = 5 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot) >4.4 V at V_{CC} = 5 V, T_A = 25°C
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

N OR PW PACKAGE
(TOP VIEW)



description/ordering information

The SN74LV8154 is a dual 16-bit binary counter with 3-state output registers, designed for 2-V to 5.5-V V_{CC} operation.

This 16-bit counter (A or B) feeds a 16-bit storage register, and each storage register is further divided into an upper byte and lower byte. The $\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, $\overline{GBU}$ inputs are used to select the byte that needs to be output at Y0−Y7. CLKA is the clock for A counter, and CLKB is the clock for B counter. RCLK is the clock for the A and B storage registers. All three clock signals are positive-edge triggered.

A 32-bit counter can be realized by connecting CLKA and CLKB together and by connecting $\overline{RCOA}$ to $\overline{CLKBEN}$.

To ensure the high-impedance state during power up or power down, $\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, and $\overline{GBU}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
−40°C to 85°C	PDIP – N	Tube	SN74LV8154N	SN74LV8154N
	TSSOP – PW	Tube	SN74LV8154PW	LV8154
		Tape and reel	SN74LV8154PWR	

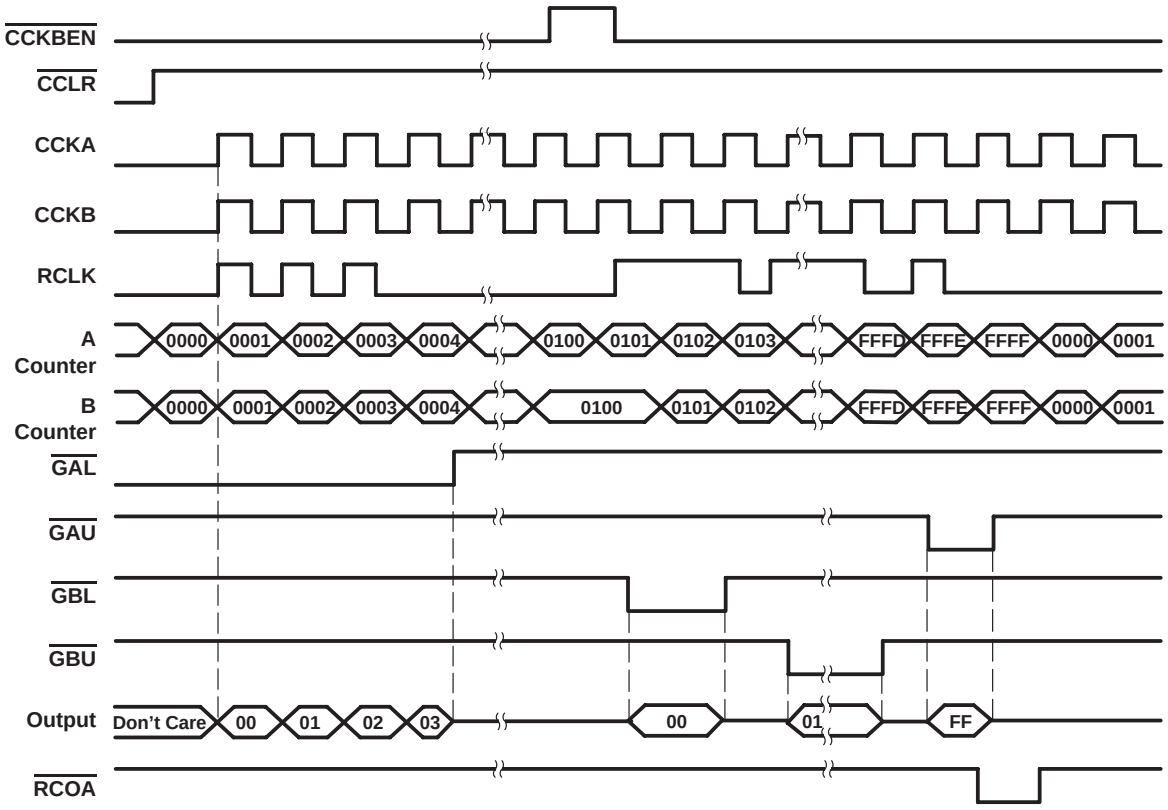
† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE
(each buffer)

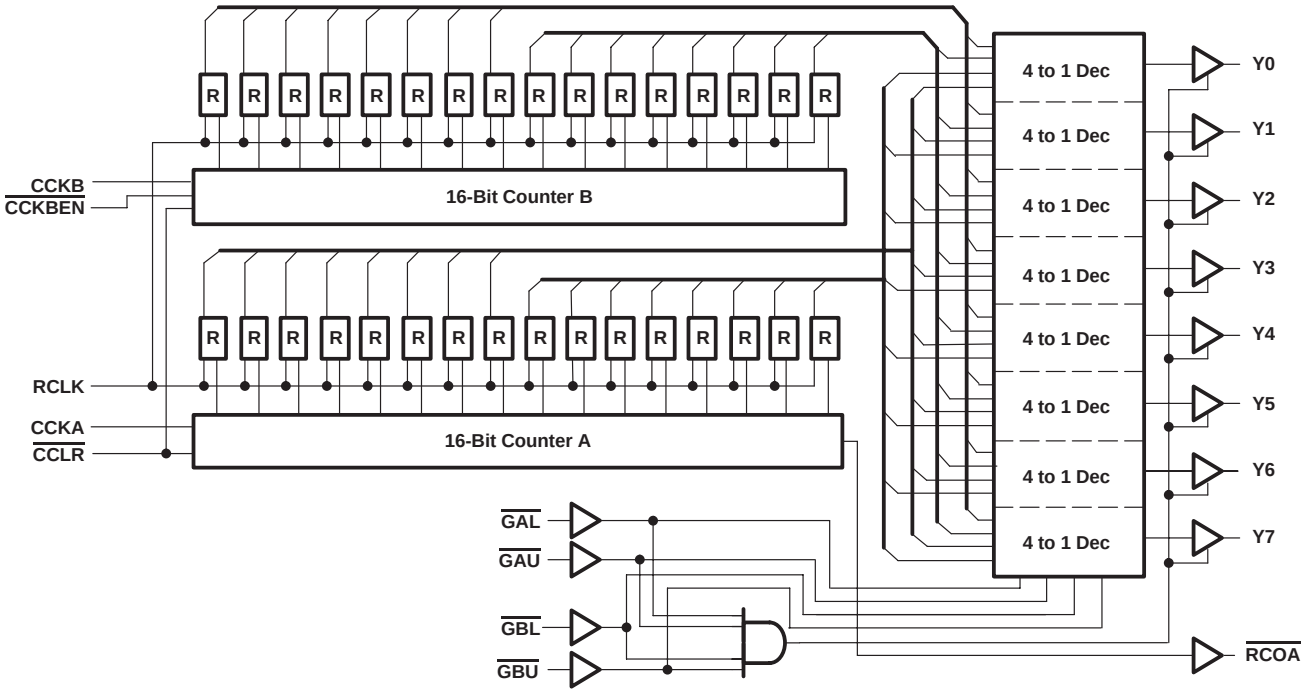
INPUTS				OUTPUT
$\overline{GAL}$	$\overline{GAU}$	$\overline{GBL}$	$\overline{GBU}$	Yn
L	H	H	H	Lower byte in A register
H	L	H	H	Upper byte in A register
H	H	L	H	Lower byte in B register
H	H	H	L	Upper byte in B register
H	H	H	H	Z

Combinations of $\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, $\overline{GBU}$, other than those shown above, are prohibited. If more than one input is L at the same time, the output data (Y0−Y7) may be invalid.

timing diagram



block diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . . −0.5 V to 7 V
Input voltage range, V_I (see Note 1) . . . . . −0.5 V to 7 V
Voltage range applied to any output in the high-impedance
or power-off state, V_O (see Note 1) . . . . . −0.5 V to 7 V
Output voltage range, V_O (see Notes 1 and 2) . . . . . −0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} (V_I < 0) . . . . . −20 mA
Output clamp current, I_{OK} (V_O < 0) . . . . . −50 mA
Continuous output current, I_O (V_O = 0 to V_{CC}) . . . . . ±35 mA
Continuous current through V_{CC} or GND . . . . . ±70 mA
Package thermal impedance, θ_{JA} (see Note 3): N package . . . . . 69°C/W
PW package . . . . . 83°C/W
Storage temperature range, T_{stg} . . . . . −65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. This value is limited to 5.5 V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

			V_{CC}	MIN	MAX	UNIT
V_{CC}	Supply voltage			2	5.5	V
V_{IH}	High-level input voltage		2 V	1.5		V
			3 V to 3.6 V	$V_{CC} \times 0.7$		
			4.5 V to 5.5 V	$V_{CC} \times 0.7$		
V_{IL}	Low-level input voltage		2 V		0.5	V
			3 V to 3.6 V		$V_{CC} \times 0.3$	
			4.5 V to 5.5 V		$V_{CC} \times 0.3$	
V_I	Input voltage			0	5.5	V
V_O	Output voltage	High or low state		0	V_{CC}	V
		3-state		0	5.5	
I_{OH}	High-level output current	Yn outputs	2 V		−50	μA
			3 V to 3.6 V		−6	mA
			4.5 V to 5.5 V		−12	
		$\overline{RCOA}$	2 V		−50	μA
			3 V to 3.6 V		−6	mA
			4.5 V to 5.5 V		−12	
I_{OL}	Low-level output current	Yn outputs	2 V		50	μA
			3 V to 3.6 V		6	mA
			4.5 V to 5.5 V		12	
		$\overline{RCOA}$	2 V		50	μA
			3 V to 3.6 V		6	mA
			4.5 V to 5.5 V		12	
$\Delta t/\Delta v$	Input transition rise or fall rate		3 V to 3.6 V		100	ns/V
			4.5 V to 5.5 V		20	
T_A	Operating free-air temperature			−40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V_{CC}	MIN	TYP	MAX	UNIT
V_{OH}	Yn	I_{OH} = −50 μA	2 V	1.9			V
		I_{OH} = −6 mA	3 V	2.48			
		I_{OH} = −12 mA	4.5 V	3.8			
	$\overline{RCOA}$	I_{OH} = −50 μA	2 V	1.9			
		I_{OH} = −6 mA	3 V	2.48			
		I_{OH} = −12 mA	4.5 V	3.8			
V_{OL}	Yn	I_{OL} = 50 μA	2 V			0.1	V
		I_{OL} = 6 mA	3 V			0.44	
		I_{OL} = 12 mA	4.5 V			0.55	
	$\overline{RCOA}$	I_{OL} = 50 μA	2 V			0.1	
		I_{OL} = 6 mA	3 V			0.44	
		I_{OL} = 12 mA	4.5 V			0.55	
I_I		V_I = 5.5 V or GND	0 to 5.5 V			±1	μA
I_{OZ}		$V_O = V_{CC}$ or GND	5.5 V			±5	μA
I_{CC}		$V_I = V_{CC}$ or GND, I_O = 0	5.5 V			20	μA
I_{off}		V_I or V_O = 0 to 5.5 V	0			5	μA
C_i		$V_I = V_{CC}$ or GND	5 V		3		pF
C_o		$V_O = V_{CC}$ or GND	5 V		5		pF

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

			MIN	MAX	UNIT
t_w	Pulse duration	CLKA, CLKB, RCLK high or low	10		ns
		$\overline{CCLR}$ low	22		
t_{su}	Setup time	$\overline{CLKBEN}$ low before CLKB↑	13		ns
		$\overline{CCLR}$ high (inactive) before CLKA↑ or CLKB↑	13		
		CLKA↑ or CLKB↑ before RCLK↑	13		
		RCLK↑ before $\overline{GAL}$ or $\overline{GAU}$ or $\overline{GBL}$ or $\overline{GBU}$ low	13		
		$\overline{GAL}$ or $\overline{GAU}$ or $\overline{GBL}$ or $\overline{GBU}$ high (inactive) before RCLK↑	13		
t_h	Hold time	$\overline{CLKBEN}$ low after CLKB↑	0		ns
		CLKA or CLKB after RCLK	0		
t_z†	Z-period	$\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, $\overline{GBU}$ all high before one of them switches low	200		ns

† t_z condition: C_L = 50 pF, R_L = 1 kΩ

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

			MIN	MAX	UNIT
t_w	Pulse duration	CLKA, CLKB, RCLK high or low	10		ns
		$\overline{\text{CCLR}}$ low	20		
t_{su}	Setup time	$\overline{\text{CLKBEN}}$ low before CLKB↑	10		ns
		$\overline{\text{CCLR}}$ high (inactive) before CLKA↑ or CLKB↑	10		
		CLKA↑ or CLKB↑ before RCLK↑	10		
		RCLK↑ before $\overline{\text{GAL}}$ or $\overline{\text{GAU}}$ or $\overline{\text{GBL}}$ or $\overline{\text{GBU}}$ low	10		
		$\overline{\text{GAL}}$ or $\overline{\text{GAU}}$ or $\overline{\text{GBL}}$ or $\overline{\text{GBU}}$ high (inactive) before RCLK↑	10		
t_h	Hold time	$\overline{\text{CLKBEN}}$ low after CLKB↑	0		ns
		CLKA or CLKB after RCLK	0		
t_z†	Z-period	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$ all high before one of them switches low	200		ns

† t_z condition: C_L = 50 pF, R_L = 1 kΩ

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			MIN	MAX	UNIT
				MIN	TYP	MAX			
f_{MAX}			C_L = 15 pF				40		MHz
			C_L = 50 pF				25		
t_{pd}	RCLK	Y	C_L = 15 pF		22		1	38	ns
	CLKA	$\overline{\text{RCOA}}$			26		1	44	
t_{PLH}	$\overline{\text{CCLR}}$	$\overline{\text{RCOA}}$			18		1	32	ns
t_{en}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y			27		1	46	ns
t_{dis}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y			12		1	21	ns
t_{pd}	RCLK	Y	C_L = 50 pF		25		1	42	ns
	CLKA	$\overline{\text{RCOA}}$			28		1	46	
t_{PLH}	$\overline{\text{CCLR}}$	$\overline{\text{RCOA}}$			20		1	35	ns
t_{en}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y			30		1	50	ns
t_{dis}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y			14		1	24	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			MIN	MAX	UNIT
				MIN	TYP	MAX			
f_{MAX}			C_L = 15 pF				40		MHz
			C_L = 50 pF				25		
t_{pd}	RCLK	Y	C_L = 15 pF		14		1	25	ns
	CLKA	$\overline{RCOA}$			16		1	27	
t_{PLH}	$\overline{CCLR}$	$\overline{RCOA}$			12		1	20	ns
t_{en}	$\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, $\overline{GBU}$	Y			16		1	28	ns
t_{dis}	$\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, $\overline{GBU}$	Y			8		1	15	ns
t_{pd}	RCLK	Y	C_L = 50 pF		16		1	27	ns
	CLKA	$\overline{RCOA}$			17		1	28	
t_{PLH}	$\overline{CCLR}$	$\overline{RCOA}$			13		1	21	ns
t_{en}	$\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, $\overline{GBU}$	Y			18		1	30	ns
t_{dis}	$\overline{GAL}$, $\overline{GAU}$, $\overline{GBL}$, $\overline{GBU}$	Y			9		1	16	ns

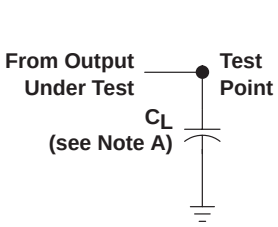
noise characteristics, V_{CC} = 5 V, C_L = 50 pF

PARAMETER		T_A = 25°C			UNIT
		MIN	TYP	MAX	
$V_{OL(P)}$	Quiet output, maximum dynamic V_{OL}		0.7		V
$V_{OL(V)}$	Quiet output, minimum dynamic V_{OL}		−0.75		V
$V_{OH(V)}$	Quiet output, minimum dynamic V_{OH}		4.4		V

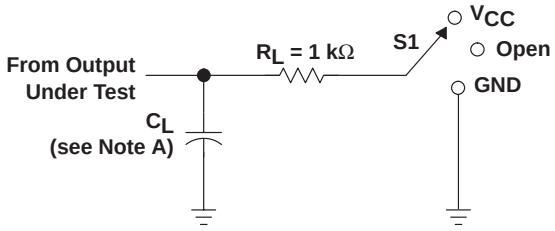
operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	C_L = No load, CCLK = 10 MHz, RCLK = 1 MHz	56	pF

PARAMETER MEASUREMENT INFORMATION

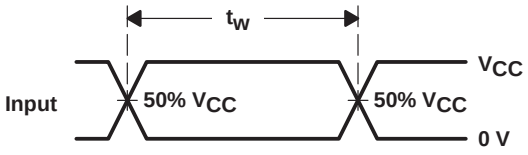


LOAD CIRCUIT FOR
TOTEM-POLE OUTPUTS

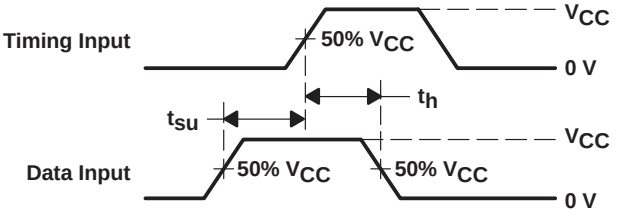


LOAD CIRCUIT FOR
3-STATE AND OPEN-DRAIN OUTPUTS

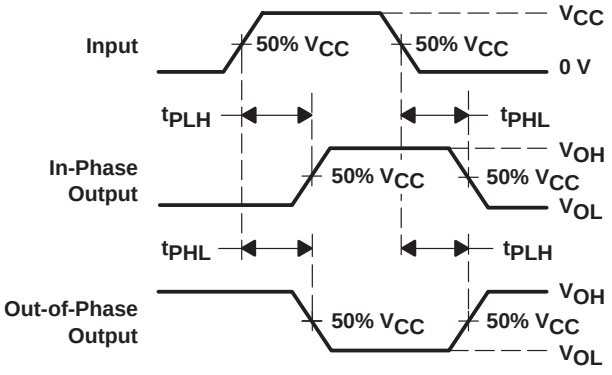
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{CC}
t_{PHZ}/t_{PZH}	GND
Open Drain	V_{CC}



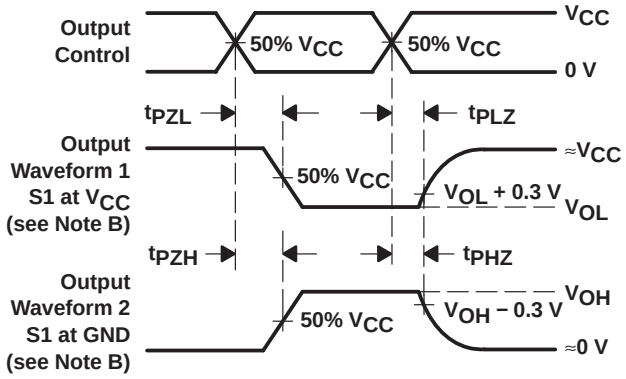
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

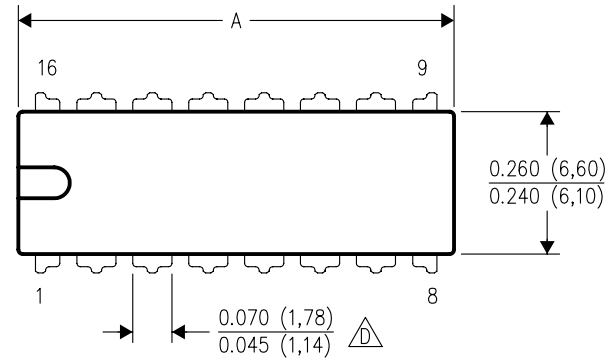
NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 3 ns, t_f ≤ 3 ns.
D. The outputs are measured one at a time, with one input transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
F. t_{PZL} and t_{PZH} are the same as t_{en}.
G. t_{PHL} and t_{PLH} are the same as t_{pd}.
H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

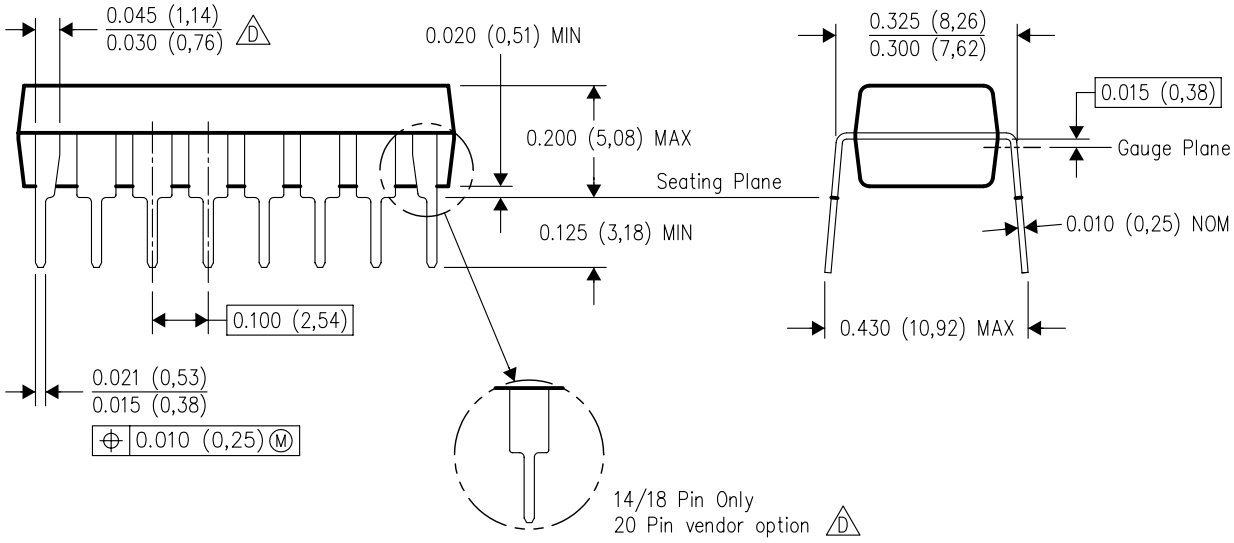
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD

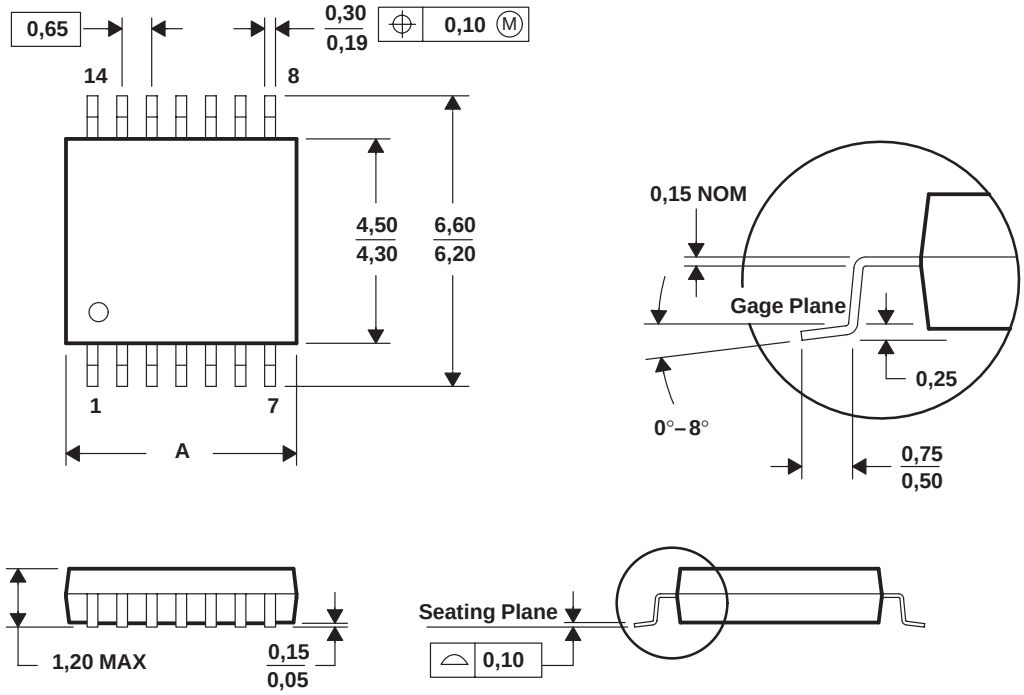


4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

PW (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



DIM \ PINS **	8	14	16	20	24	28
A MAX	3,10	5,10	5,10	6,60	7,90	9,80
A MIN	2,90	4,90	4,90	6,40	7,70	9,60

4040064/F 01/97

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265